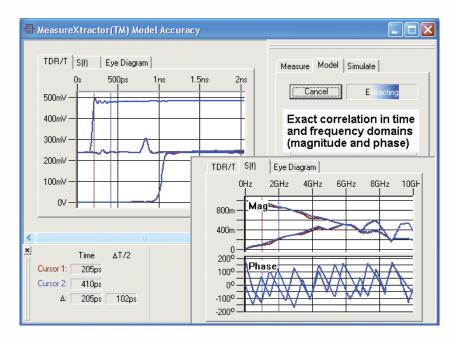
MeasureXtractor Software

► 80SICMX



The Fastest Way from TDR/T or VNA Measurements to Simulations

As the complexity and speed of digital systems increase, modeling the complex high-frequency effects occurring in the high-speed interconnects is becoming an increasingly challenging task, requiring large amounts of design time.

MeasureXtractor is an automated model extraction tool, allowing the designer to obtain an accurate measurement based on the SPICE model of the interconnect, with the press of a button.

MeasureXtractor will guide you through the data acquisition process, help you acquire TDR/T or VNA S-parameter data, and will automatically produce an accurate model that matches both the time and frequency response of your interconnect. Losses, dispersion, jitter, crosstalk and reflections and ringing are predicted accurately, up to the highest frequency of operation of your instrument. Passivity of models must be explicitly enforced during model extraction, and MeasureXtractor model passivity is assured through the proprietary algorithm. This means that interconnect models generated with MeasureXtractor will not artificially amplify the signal, oscillate, or produce non-causal results when used in systemlevel simulations.

Behavioral Models

MeasureXtractor produces what is known as a behavioral model. Such a model does not take into account the actual topology of the interconnect, but instead simply aims to accurately represent the time and frequency behavior of the interconnect in the most simulation efficient manner; in the case of MeasureXtractor, that means with the minimum number of components, and guaranteed passivity. Nonetheless, behavioral models can result in longer simulation time, particularly for large interconnect structures.

▶ Characteristics

Recommended Instrument Compatibility

- ► Tektronix CSA/TDS8200 or CSA/TDS8000, with 80E04 TDR sampling module (local TekVISA™ interface is supported; install and run directly on the instrument)
- ► Tektronix 11801 and CSA803 mainframes with SD24 TDR sampling module

Computer Requirements

Processor – 400 MHz Intel Pentium.
RAM –

256 MB (1 GB recommended for large MeasureXtractor runs). Hard Drive – 40 MB free space. Operating System – Windows 95/98/NT4.0/2000/XP. Features & Benefits

Automatically Convert TDR/T or VNA Data into SPICE Models

- Measurement Based, Frequency Dependent, Exact Models
- Model Passivity, Stability, Causality Guaranteed

Easily Ensure System Level Simulation Accuracy

Easily Perform Interconnect Link Analysis

Applications

High-speed Component Testing Serial Data Testing Consumer Electronics

Communications Testing



► Comparison of Behavioral and Topological Modeling Approaches

Behavioral

Requires full-port measurement

Automatic, no user intervention

Automatic, no user intervention

"Black-box," no internal changes allowed

Large model size for long interconnects

(backplanes, cable assemblies)

Quick inclusion of S-parameter or

TDR/T measurements into simulation;

the "do-it-all" modeling tool

Measurement

Requirements

Topology Selection

Model Extraction

Type of Models

Limitations

Application

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Our most up-to-date product information is available at: www.tektronix.com



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Topological

Just TDR (reflection) is sufficient

User-controlled (easy and intuitive

from TDR measurements)

User-driven; more labor intensive

and requires more skill

Intuitive, topology correlates to model

Efficient model extraction processes

exist for large interconnects

Comprehensive modeling, "what-if"

scenarios analysis, signal integrity

troubleshooting and fault-finding

IConnect and MeasureXtractor

Opt. SWS1 – Extend maintenance agreement by

Opt. SWS2 – Extend maintenance agreement by

Opt. SWS3 – Extend maintenance agreement by

Opt. CUR - Renew a license that is out of support.

Extensions to Existing

Maintenance Agreements

80SICMXMNT

one year.

two years.

three years.

80SSPARUP

to 80SICMX

hardware key (dongle).

80SICONUP

key (dongle).

Upgrade from 80SICON to 80SICMX

Upgrade from 80SSPAR

Opt. ICMXUSB - Upgrade with USB hardware

Opt. ICMXPPD - Upgrade with parallel port

Opt. ICMXUSB – Upgrade with USB hardware key (dongle).

Opt. ICMXPPD - Upgrade with parallel port hardware key (dongle).

Monitor -

Additional external monitor is recommended. Others -

National Instruments GPIB board, version 2.1 (not required for Tektronix CSA/TDS8xxx local TekVISA™ interface).

▶ Ordering Information

80SICMX

IConnect and MeasureXtractor Signal Integrity TDR and VNA Software.

Includes: First year of maintenance and support from date of purchase.

As an Option to the CSA8200 or TDS8200 Oscilloscopes

Opt. ICMX - Pre-install product on a new CSA/TDS8200 Series Oscilloscope.*1

Options

Options to Stand-alone **Product**

Opt. USB - USB hardware key (dongle).

Opt. PPD - Parallel port hardware key (dongle).

Opt. SWS2 - Extend maintenance agreement to two years from date of purchase.

Opt. SWS3 – Extend maintenance agreement to three years from date of purchase.

^{*1} Only parallel port hardware key is offered.